

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t1910es8#pbf

(Engineering Calculation)

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**TOTAL MASS (g) : 0.072851**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001613	1000000	22141.1269531		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.023653	975000	324677.0625		
		Iron (Fe)	7439-89-6	0.000582	24000	7988.92529297		
		Phosphorus (P)	7723-14-0	0.000007	300	96.0867233276		
		Zinc (Zn)	7440-66-6	0.000017	700	233.353485107		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.024259</b>	<b>1000000</b>	<b>332995.40625</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001477	1000000	20272.2675781		
		<b>External Plating Total:</b>				<b>0.001477</b>	<b>1000000</b>	<b>20272.2675781</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000194	1000000	2662.97485352		
<b>Internal Plating Total:</b>				<b>0.000194</b>	<b>1000000</b>	<b>2662.97485352</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000614	750000	8428.17871094		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000205	250000	2813.96850586		
<b>Die Attach Total:</b>				<b>0.000819</b>	<b>1000000</b>	<b>11242.1474609</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.004571	103000	62744.6328125		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.039720	895000	545223.5625		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000089	2000	1221.67419434		
		<b>Encapsulation Total:</b>				<b>0.044380</b>	<b>1000000</b>	<b>609189.875</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000109	1000000	1496.20751953		
					<b>TOTAL MASS (g) :</b>	<b>0.072851</b>		